

62823

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of
PENDSE et al.

Application No.: 09/802,443

Filed: March 9, 2001

Title: **Flip chip-in-leadframe
package and process**

Examiner: Deven M. Collins

Group Art Unit: 2823

Date: June 28, 2002

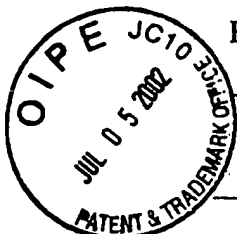
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TRANSMITTAL LETTER

Commissioner of Patents
Washington, D.C. 20231


Dear Sir:

In response to the Office Action mailed May 29, 2002 (Restriction Requirement),
enclosed please find:

- [X] Preliminary Amendment and Response to Restriction Requirement;
- [X] Separate Letter to Official Draftsperson and two (2) sheets of corrected
formal drawings;
- [X] Information Disclosure Statement (in duplicate);
- [X] PTO-1449 (PTO/SB/08A) form and copy of cited reference.

The Commissioner is hereby authorized to charge any additional fees that may be required by this paper, and to credit any overpayment, to Deposit Account No. 50-0869 (Docket No. CPAC 1001-1US). A duplicate of this paper is enclosed.

Respectfully submitted,

 Reg. No. 33,407

Bill Kennedy
Registration No. 33,407

Date: June 28, 2002

HAYNES BEFFEL & WOLFELD LLP
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Half Moon Bay, CA 94019
(650) 712-0340

Attorney Docket No.: CPAC 1001-1 US
USSN 09/802,443

PATENT

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SEPARATE LETTER TO OFFICIAL DRAFTSPERSON

Official Draftsperson
Commissioner Of Patents
Washington, D.C. 20231

Official Draftsperson:

In connection with the above-referenced U. S. patent application, transmitted
herewith are the following papers:

- [X] Two (2) sheets of formal drawings. Sheet 2 (Fig. 4) contains a drawing
correction made by the Preliminary Amendment filed June 28, 2002.

Authorization is hereby given to deduct from or credit to Deposit Account
No. 50-0869 (CPAC 1001-1 US), any fees that may be required with this matter. A
duplicate of this paper is enclosed.

Respectfully submitted,

Bill Kennedy
Registration No. 33,407

Date: June 28, 2002
Haynes Beffel & Wolfeld LLP
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Half Moon Bay, CA 94019
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